IGBT - Field Stop

600 V, 40 A

FGH40N60UF

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switch-ing losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} @ \text{ I}_{C} = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- These Device is Pb-Free and is RoHS Compliant

Applications

• Solar Inverter, UPS, Welder, PFC

ABSOLUTE MAXIMUM RATINGS

Description		Symbol	Value	Unit
Collector to Emitter Voltage		V _{CES}	600	V
Gate to Emitter Voltage		V _{GES}	±20	V
Transient Gate to Emitter Voltage			±30	
Collector Current	$T_C = 25^{\circ}C$	Ι _C	80	А
Collector Current	$T_{\rm C} = 100^{\circ}{\rm C}$		40	А
Pulsed Collector Current (Note 1)	T _C = 25°C	I _{CM}	120	A
Maximum Power Dissipation	$T_{C} = 25^{\circ}C$	PD	290	W
Maximum Power Dissipation	T _C = 100°C	1	116	W
Operating Junction Temperature		ТJ	–55 to +150	°C
Storage Temperature Range		T _{stg}	–55to +150	°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		ΤL	300	°C

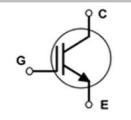
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.



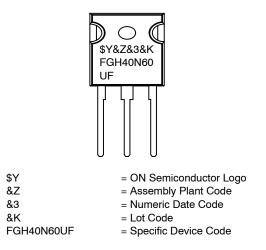
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MARKING DIAGRAMS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (IGBT)	-	0.43	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH40N60UFTU	FGH40N60UF	TO-247-3	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Off Characteristics						
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 250 μ A	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	V_{GE} = 0 V, I _C = 250 μ A		0.6		V/∘C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Characteristics						
G-E Threshold Voltage	V _{GE(th)}	$I_C = 250 \ \mu A, \ V_{CE} = V_{GE}$	4.0	5.0	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	1.8	2.4	V
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 125°C	-	2.0	-	V
Dynamic Characteristics						
Input Capacitance	Cies	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	2110	-	pF
Output Capacitance	C _{oes}		_	200	-	pF
Reverse Transfer Capacitance	C _{res}		-	60	-	pF
Switching Characteristics	-					
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_C = 40 \text{ A},$	-	24	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	44	-	ns
Turn-Off Delay Time	t _{d(off)}		-	112	-	ns
Fall Time	t _f		-	30	60	ns
Turn-On Switching Loss	E _{on}		-	1.19	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.46	-	mJ
Total Switching Loss	E _{ts}		_	1.65	-	mJ
Turn-On Delay Time	t _{d(on)}	V_{CC} = 400 V, I_C = 40 A, R_G = 10 $\Omega,$ V_{GE} = 15 V, Inductive Load, T_C = 125°C	_	24	-	ns
Rise Time	t _r		_	45	-	ns
Turn-Off Delay Time	t _{d(off)}		_	120	-	ns
Fall Time	t _f		-	40	-	ns
Turn–On Switching Loss	E _{on}		_	1.2	-	mJ
Turn–Off Switching Loss	E _{off}		_	0.69	-	mJ
Total Switching Loss	E _{ts}		_	1.89	-	mJ
Total Gate Charge	Qg	V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	120	-	nC
Gate to Emitter Charge	Q _{ge}		_	14	-	nC
Gate to Collector Charge	Q _{gc}		_	58	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

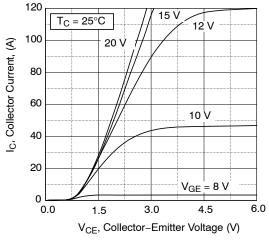
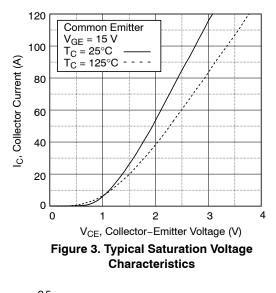


Figure 1. Typical Output Characteristics



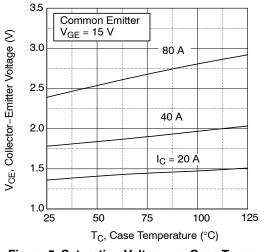


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

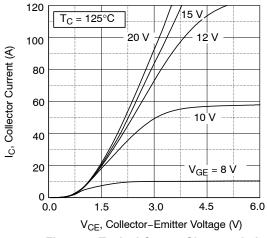
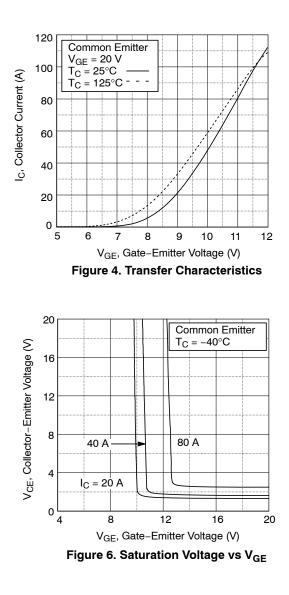


Figure 2. Typical Output Characteristics



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

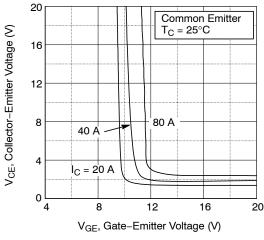


Figure 7. Saturation Voltage vs. V_{GE}

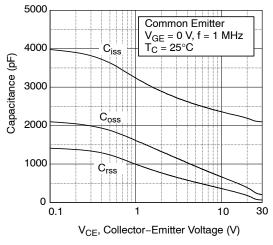
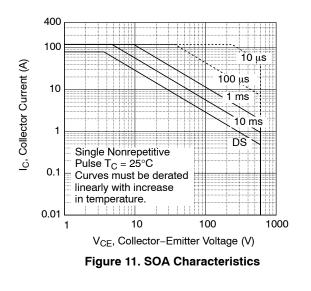


Figure 9. Capacitance Characteristics



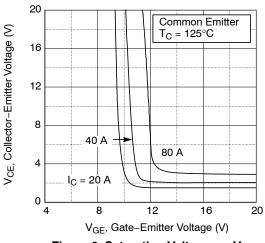


Figure 8. Saturation Voltage vs. V_{GE}

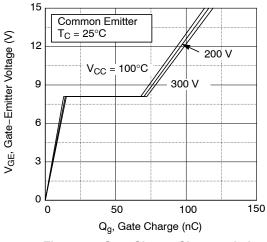
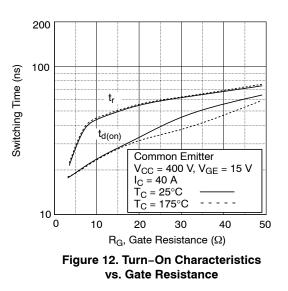


Figure 10. Gate Charge Characteristics

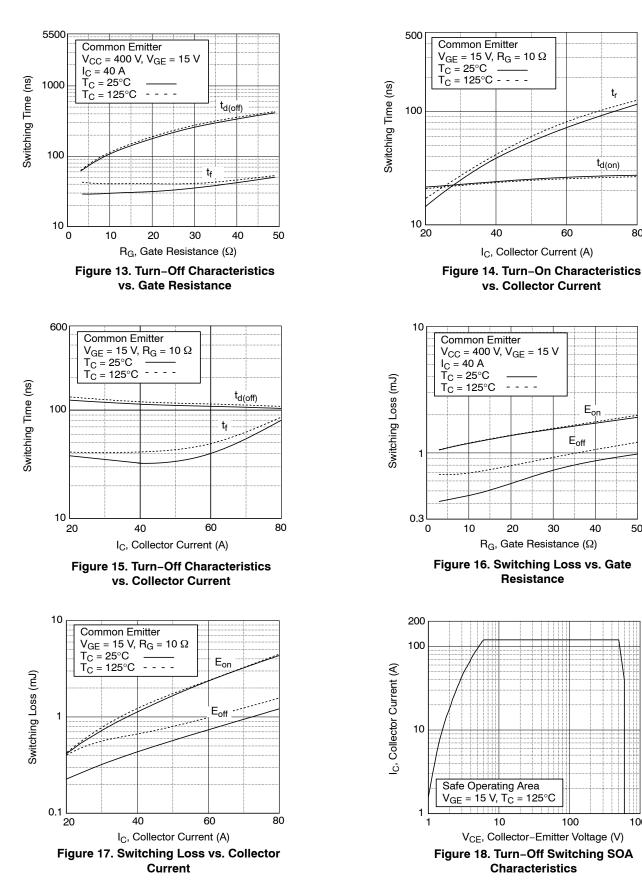


80

50

1000

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

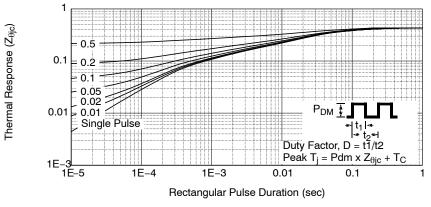


Figure 19. Transient Thermal Impedance of IGBT





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